

# LATEST NEWS

***NEW!!!***



## **[ESCC Hybrid Process Capability Approval List \(HPCL\)](#)**

The New ESCC HPCL was published February 2019. This is a list of active and valid Process Capability Approval Certificates for manufacturing Lines of Hybrid Microcircuits, the ESCC HPCL (Hybrid Process Capability Approval List).

For more information, please click [HERE](#)



## **[ESCC QPL January 2019](#)**

The ESCC QPL January was published with 3 extensions, 1 extension with re-scope, 2 revisions, and 2 amendments.

For more information, please click [HERE](#)



## **[ESCC QML January 2019](#)**

The ESCC QML was published with pulished with 1 new certificate from Exxelia SAS and 1 deletion. For more information, please click [HERE](#)



## **NEW ESCC Specifications Published:**

**December 2018:** There were *1* NEW ESCC Basic Specification published in December!!

**[ESCC 2567000 issue 1](#)**: REQUIREMENTS FOR PROCESS CAPABILITY APPROVAL OF ASSEMBLY AND TEST HOUSE (ATH) SERVICES

## **[EPPL \( European Preferred Parts List \) issue 37](#)**



The ESCC EPPL issue 37 was published December 2018.

## UPCOMING EVENTS



### [ESCCON 2019](#)

The Space Components Steering Board of the European Space Components Coordination (ESCC) has the pleasure to announce the European Space Components Conference ESCCON 2019. Click [HERE](#) for more information



### [EMPS Workshops](#)

The Tenth Electronic Materials and Processes for Space workshop will be held in Villepinte, France 15-16 May 2019. For more information, please click [HERE](#)



### [NSREC 2019](#)

IEEE Nuclear and Space Radiation Effects conference will take place July 8th to 12th 2019, at the San Antonio Marriott River Center, Texas USA. For more information please click [HERE](#)



### [RADECS 2019](#)

Radiation Effects on Components and Systems conference will take place from 16th to 20th of September 2019. For more information please click [HERE](#)

## RECENTLY PUBLISHED ESCC SPECIFICATION

### New ESCC Specifications published since 15th December 2018

Number	Title	I
<a href="#">2567000</a>	REQUIREMENTS FOR PROCESS CAPABILITY APPROVAL OF ASSEMBLY AND TEST HOUSE (ATH) SERVICES	1

### Up-Issued ESCC Specifications published since 15th December 2018

Number	Title
<a href="#">3401/041</a>	Connector Savers Electrical Rectangular Microminiature, based on type MDM
<a href="#">3401/077</a>	Connectors, Electrical, Rectangular, Microminiature, Removable Crimp Contacts, Based on Type MDMA

<a href="#">3702/001</a>	Switches Thermostatic Bimetallic SPDT Opening Contact
<a href="#">5207/009</a>	Transistors, Low Power, Complementary NPN/PNP Based on type 2ST3360

To view the December 2018 What's New page, please click [HERE](#)